

November 2013

# ISL9R860PF2 8 A, 600 V, STEALTH™ Diode

### **Features**

- Stealth Recovery  $t_{rr}$  = 28 ns (@I<sub>F</sub> = 8 A)
- Max Forward Voltage, V<sub>F</sub> = 2.4 V (@ T<sub>C</sub> = 25°C)
- 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

### **Applications**

- Switch Mode Power Supplies
- · Hard Switched PFC Boost Diode
- · UPS Free Wheeling Diode
- · Motor Drive FWD
- SMPS FWD
- Snubber Diode

## Description

The ISL9R860PF2 is a STEALTH™ diode optimized for low loss performance in high frequency hard switched applications. The STEALTH™ family exhibits low reverse recovery current (I<sub>rr</sub>) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I<sub>rr</sub> and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH™ diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

# Package Symbol









## Device Maximum Ratings T<sub>C</sub>= 25°C unless otherwise noted

Symbol	Parameter	Ratings	
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V
V <sub>R</sub>	DC Blocking Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (T <sub>C</sub> = 75°C)	8	Α
I <sub>FRM</sub>	Repetitive Peak Surge Current (20 kHz Square Wave)	16	Α
I <sub>FSM</sub>	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	100	Α
P <sub>D</sub>	Power Dissipation	26	W
E <sub>AVL</sub>	Avalanche Energy (1 A, 40 mH)	20	m.
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150	°C
T <sub>L</sub>	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10s	300	°C

CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Part Number		Top Mark	Package F	Packing Method	d Reel Size	Tape Width		Qı	Quantity 50	
ISL9R860PF2		ISL9R860PF2	TO-220F-2L	Tube	N/A					
Electric	cal (	Characteris	stics T <sub>C</sub> = 25°	C unless otherwise n	oted					
Symbol	Parameter			Test Conditions		Min	Тур	Max	Unit	
Off State	Cha	aracteristics								
I <sub>R</sub>	Insta	antaneous Revers	se Current	V <sub>R</sub> = 600 V	T <sub>C</sub> = 25°C	-	-	100	μА	
					T <sub>C</sub> = 125°C	-	-	1.0	mA	
On State	Cha	aracteristics					•	•		
		nstantaneous Forward Voltage		I <sub>F</sub> = 8 A	T <sub>C</sub> = 25°C		2.0	2.4	V	
<b>V</b> F	111310	antaneous i oiwa	ra voltage	1F = 0 X	$T_{\rm C} = 125^{\circ}{\rm C}$	_	1.6	2.0	V	
Dynamic <sub>C」</sub>		aracteristics ction Capacitance	<b>.</b>	V <sub>R</sub> = 10 V , I <sub>F</sub> = 0 /	A	_	30	-	pF	
	1	naracteristics		K 2 7 1		<u>I</u>	1			
t <sub>rr</sub>	-		$I_F = 1 \text{ A, } di_F/dt = 1$	00 A/μs, V <sub>R</sub> = 30 V	' -	18	25	ns		
					$I_F = 8 \text{ A}, di_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		21	30	ns	
t <sub>rr</sub>	Reve	erse Recovery Ti	me	I <sub>F</sub> = 8 A,			28	-	ns	
I <sub>rr</sub>	Maximum Reverse Recovery Current		$di_F/dt = 200 A/\mu s$ ,			3.2	-	Α		
Q <sub>rr</sub>	Reve	Reverse Recovery Charge		$V_R = 390 \text{ V}, T_C = 25^{\circ}\text{C}$		-	50	-	nC	
t <sub>rr</sub>	Reve	erse Recovery Ti	me	I <sub>F</sub> = 8 A,	•		77	-	ns	
S	Softness Factor (t <sub>b</sub> /t <sub>a</sub> )  Maximum Reverse Recovery Current		$di_F/dt = 200 A/\mu s$	$di_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V},$ $T_C = 125^{\circ}\text{C}$		3.7	-			
I <sub>rr</sub>			1,4			3.4	-	Α		
Q <sub>rr</sub>	Reve	erse Recovery Cl	narge	- 1 <sub>C</sub> = 125 C			150	-	nC	
t <sub>rr</sub>	Reve	erse Recovery Ti	me	I <sub>F</sub> = 8 A,			53	-	ns	
S	Softness Factor (t <sub>b</sub> /t <sub>a</sub> )  Maximum Reverse Recovery Current		$di_F/dt = 600 \text{ A/}\mu\text{s},$	$di_F/dt = 600 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V},$ $T_C = 125^{\circ}\text{C}$		2.5	-			
I <sub>rr</sub>						6.5	-	Α		
Q <sub>rr</sub>	Reve	erse Recovery Cl	narge	1 <sub>C</sub> = 123 C		195	-	nC		
dl <sub>M</sub> /dt	Max	imum di/dt during	ı t <sub>b</sub>			- /	500	-	A/µs	
Thermal	Cha	racteristics								
$R_{\theta JC}$	Thermal Resistance Junction to Case					/ -	-	4.8	°C/W	
, (A)C								-		

# **Typical Performance Curves** 16 14 12 FORWARD CURRENT (A) 10 8 6 2 1.25 1.5 1.75 0.25 0.5 0.75 V<sub>F</sub>, FORWARD VOLTAGE (V) Figure 1. Forward Current vs Forward Voltage $V_R = 390V, T_J = 125$ °C 70 $t_b AT d_F/dt = 200A/\mu s, 500A/\mu s, 800A/\mu s$ 60 RECOVERY TIMES 50 40

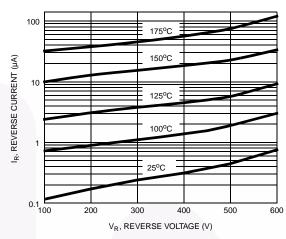


Figure 2. Reverse Current vs Reverse Voltage

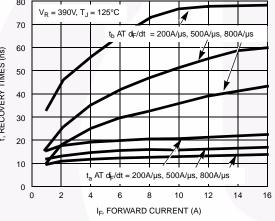


Figure 3. t<sub>a</sub> and t<sub>b</sub> Curves vs Forward Current

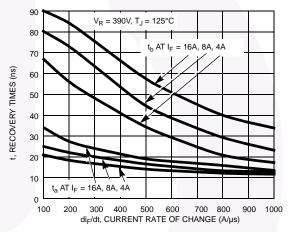


Figure 4. t<sub>a</sub> and t<sub>b</sub> Curves vs di<sub>F</sub>/dt

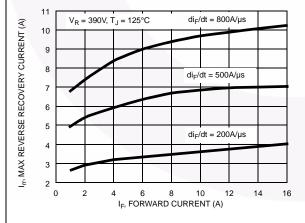


Figure 5. Maximum Reverse Recovery Current vs **Forward Current** 

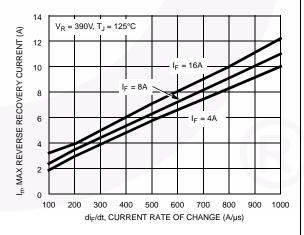
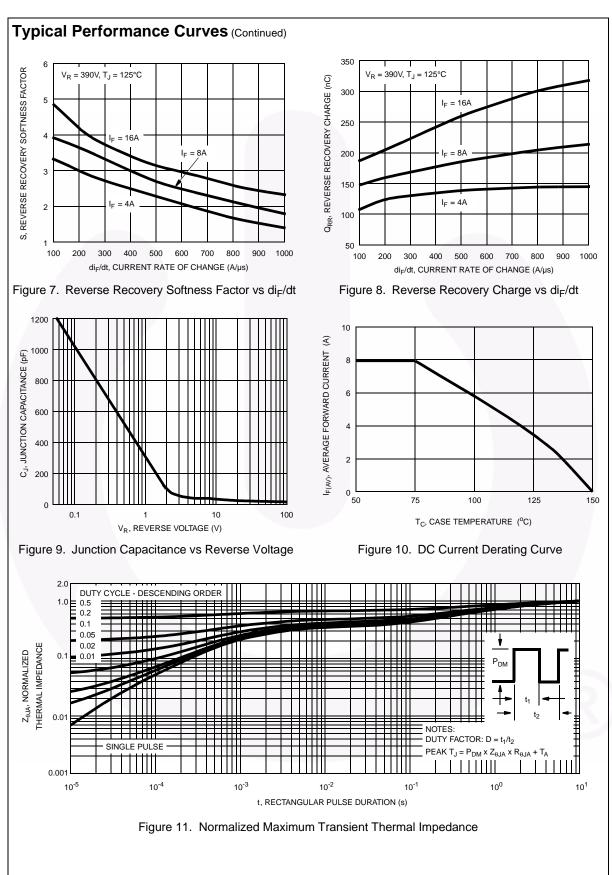
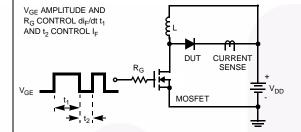


Figure 6. Maximum Reverse Recovery Current vs di<sub>F</sub>/dt



## **Test Circuits and Waveforms**



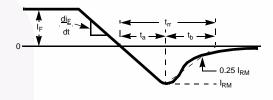
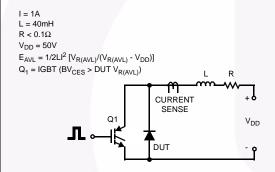


Figure 12. t<sub>rr</sub> Test Circuit

Figure 13. t<sub>rr</sub> Waveforms and Definitions



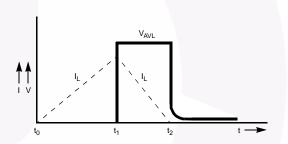


Figure 14. Avalanche Energy Test Circuit

Figure 15. Avalanche Current and Voltage Waveforms

## **Mechanical Dimensions**

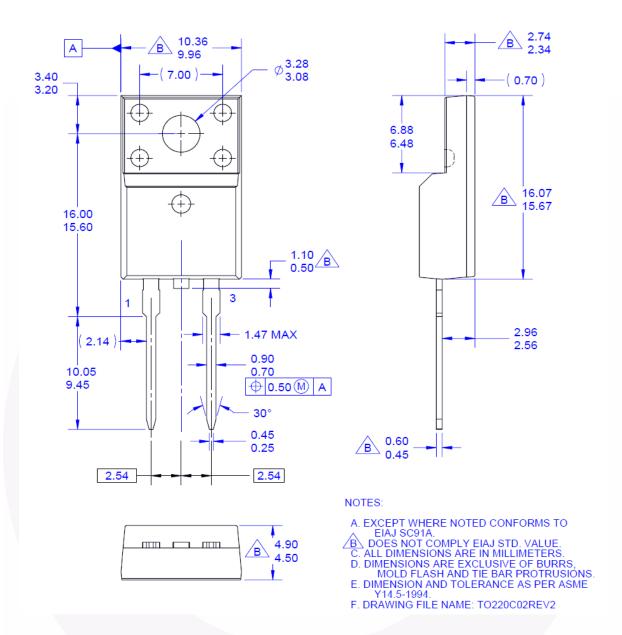


Figure 16. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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